## CPC COOPERATIVE PATENT CLASSIFICATION

H03B GENERATION OF OSCILLATIONS, DIRECTLY OR BY FREQUENCY-CHANGING, BY CIRCUITS EMPLOYING ACTIVE ELEMENTS WHICH OPERATE IN A NON-SWITCHING MANNER; GENERATION OF NOISE BY SUCH CIRCUITS (measuring,

testing <u>G01R</u>; generators adapted for electrophonic musical instruments <u>G10H</u>; Speech synthesis <u>G10L</u>; masers, lasers <u>H01S</u>; dynamo-electric machines <u>H02K</u>; power inverter circuits <u>H02M</u>; by using pulse techniques <u>H03K</u>; automatic control of generators <u>H03L</u>; starting, synchronisation or stabilisation of generators where the type of generator is irrelevant or unspecified <u>H03L</u>; generation of oscillations in plasma <u>H05H</u>)

1/00	Details	5/1231 {the amplifier comprising one or more bipolar
1/02	<ul> <li>Structural details of power oscillators, e.g. for heating {(construction of transmitters H04B; features of generators for heating by electromagnetic fields H05B 6/00)}</li> </ul>	transistors}  5/1234 • • • {and comprising means for varying the output amplitude of the generator (H03B 5/1278 takes precedence)}
1/04	• Reducing undesired oscillations, e.g. harmonics	5/1237 {comprising means for varying the frequency
5/00	Generation of oscillations using amplifier with regenerative feedback from output to input	of the generator} 5/124 • • • {the means comprising a voltage dependent capacitance}
5/02	( <u>H03B 9/00</u> , <u>H03B 15/00</u> take precedence)  Details	5/1243 {the means comprising voltage variable
5/04	Modifications of generator to compensate for variations in physical values, e.g. power supply, load, temperature	capacitance diodes } 5/1246 {the means comprising transistors used to provide a variable capacitance}
5/06	Modifications of generator to ensure starting of	5/125 {the transistors being bipolar transistors}
5/08	oscillations  with frequency-determining element comprising	5/1253 {the transistors being field-effect transistors}
5/10	lumped inductance and capacitance  . active element in amplifier being vacuum tube (H03B 5/14 takes precedence)	5/1256 {the means comprising a variable inductance}
5/12	<ul> <li>active element in amplifier being semiconductor device (H03B 5/14 takes precedence)</li> </ul>	5/1259 {the means comprising a variable active inductor, e.g. gyrator circuits}
	WARNING	5/1262 {the means comprising switched elements} 5/1265 {switched capacitors}
	Subgroups <u>H03B 5/1203</u> - <u>H03B 5/1296</u> are	5/1268 {switched inductors}
	incomplete pending reclassification; see also the other subgroups of H03B 5/12	5/1271 {the frequency being controlled by a control current, i.e. current controlled oscillators}
5/1203	• • • {the amplifier being a single transistor}	5/1275 {having further means for varying a parameter in dependence on the frequency}
5/1206 5/1209	<ul><li> {using multiple transistors for amplification}</li><li> {the amplifier having two current paths operating in a differential manner and a</li></ul>	5/1278 { the parameter being an amplitude of a signal, e.g. maintaining a constant output amplitude over the frequency range}
	current source or degeneration circuit in common to both paths, e.g. a long-tailed pair.	5/1281 { the parameter being the amount of feedback}
5/1212	<ul> <li>(H03B 5/1215 takes precedence)}</li> <li> {the amplifier comprising a pair of transistors, wherein an output terminal of</li> </ul>	5/1284 { the parameter being another frequency, e.g. a harmonic of the oscillating frequency}
5/1215	<ul><li>each being connected to an input terminal of the other, e.g. a cross coupled pair}</li><li> {the current source or degeneration circuit</li></ul>	5/1287 { the parameter being a quality factor, e.g. Q factor of the frequency determining element }
	being in common to both transistors of the pair, e.g. a cross-coupled long-tailed pair}	5/129 {the parameter being a bias voltage or a power supply}
5/1218	• • • {the generator being of the balanced type}	5/1293 • • • • {having means for achieving a desired tuning
5/1221	<ul><li> {the amplifier comprising multiple amplification stages connected in cascade}</li><li> {the generator comprising multiple</li></ul>	characteristic, e.g. linearising the frequency characteristic across the tuning voltage
5/1225	amplifiers connected in parallel	range }  5/1296 • • • {the feedback circuit comprising a transformer}
5/1228	• • • {the amplifier comprising one or more field effect transistors}	5/14 • frequency-determining element connected via bridge circuit to closed ring around which signal is transmitted

5/16 5/18	<ul> <li>active element in amplifier being vacuum tube</li> <li>with frequency-determining element comprising</li> </ul>	5/34	• • • active element in amplifier being vacuum tube (H03B 5/38 takes precedence)
5/1805	distributed inductance and capacitance  . {the frequency-determining element being a	5/36	• • • active element in amplifier being semiconductor device ({H03B 5/323,
	coaxial resonator}		$\underline{\text{H03B 5/326}}$ , $\underline{\text{H03B 5/38}}$ take precedence)
5/1811	<ul> <li>. • {the active element in the amplifier being a vacuum tube (see provisionally also H03B 5/1835)}</li> </ul>	5/362	• • • {the amplifier being a single transistor (H03B 5/364 - H03B 5/368 take precedence)}
5/1817	the frequency-determining element being a cavity resonator	5/364	• • • { the amplifier comprising field effect transistors (H03B 5/366 takes precedence) }
5/1823	• • • {the active element in the amplifier being a semiconductor device}	5/366	• • • { and comprising means for varying the frequency by a variable voltage or current}
5/1829	• • • {the semiconductor device being a field- effect device}	5/368	• • • • {the means being voltage variable capacitance diodes}
5/1835	• • • {the active element in the amplifier being a vacuum tube}	5/38	frequency-determining element being connected via bridge circuit to closed ring
5/1841	<ul> <li>{the frequency-determining element being a strip line resonator (H03B 5/1805, H03B 5/1817, H03B 5/1864 and H03B 5/1882 take precedence)}</li> </ul>	5/40	<ul> <li>around which signal is transmitted</li> <li>being a magnetostrictive resonator (H03B 5/42 takes precedence; selection of magneto-strictive material {H01F 1/00}; H01L 41/00)</li> </ul>
5/1847	• • { the active element in the amplifier being a semiconductor device }	5/42	<ul> <li>frequency-determining element connected via bridge circuit to closed ring around which signal is transmitted</li> </ul>
5/1852	<ul> <li> {the semiconductor device being a field- effect device}</li> </ul>		
5/1858	• • • {the active element in the amplifier being	7/00	Generation of oscillations using active element having a negative resistance between two of its
	a vacuum tube ( <u>see</u> provisionally also H03B 5/1835)}		electrodes (H03B 9/00 takes precedence)
5/1864	the frequency-determining element being a dielectric resonator}	7/02	<ul> <li>with frequency-determining element comprising lumped inductance and capacitance</li> </ul>
5/187	• • • {the active element in the amplifier being a	7/04	active element being vacuum tube
2, 20,	semiconductor device}	7/06	. active element being semiconductor device
5/1876	{ the semiconductor device being a field-	7/08 7/10	<ul><li> being a tunnel diode</li><li>. active element being gas-discharge or arc-</li></ul>
5/100 <b>3</b>	effect device}	//10	discharge tube
5/1882	<ul> <li>• {the frequency-determining element being a magnetic-field sensitive resonator, e.g. a Yttrium Iron Garnet or a magnetostatic surface wave</li> </ul>	7/12	<ul> <li>with frequency-determining element comprising distributed inductance and capacitance</li> </ul>
	resonator}	7/14	active element being semiconductor device
5/1888	• • • {the active element in the amplifier being a	7/143	• • • {and which comprises an element depending
<b>7</b> /1004	semiconductor device}		on a voltage or a magnetic field, e.g. varactor- YIG}
5/1894	• • • {the semiconductor device being a field- effect device}	7/146	• • • {with several semiconductor devices}
5/20	<ul> <li>with frequency-determining element comprising resistance and either capacitance or inductance, e.g.</li> </ul>	9/00	Generation of oscillations using transit-time effects {(construction of tube and circuit arrangements not
	phase-shift oscillator		adapted to a particular application H01J; construction
5/22	active element in amplifier being vacuum tube		of the semiconductor devices <u>H01L</u> )}
	( <u>H03B 5/26</u> takes precedence)	9/01	<ul> <li>using discharge tubes</li> </ul>
5/24	<ul> <li>active element in amplifier being semiconductor device (<u>H03B 5/26</u> takes precedence)</li> </ul>	9/02	• using a retarding-field tube (using klystrons H03B 9/04)
5/26	frequency-determining element being part of	9/04	• using a klystron
	bridge circuit in closed ring around which signal is transmitted; frequency-determining element	9/06	using a reflex klystron
	being connected via a bridge circuit to such a	9/08	• using a travelling-wave tube
	closed ring, e.g. Wien-Bridge oscillator, parallel-	9/10	• using a magnetron
	T oscillator	9/12 2009/123	<ul><li>using solid state devices, e.g. Gunn-effect devices</li><li>. {using Gunn diodes}</li></ul>
5/28	active element in amplifier being vacuum tube	2009/126	<ul> <li>• {using Guilli diodes}</li> <li>• {using impact ionization avalanche transit time</li> </ul>
5/30	with frequency-determining element being electromechanical resonator	9/14	[IMPATT] diodes} . and elements comprising distributed inductance
5/32	being a piezo-electric resonator (selection of piezo-electric material H01L 41/00)	9/141	and capacitance  {and comprising distributed inductance}
5/323	• • • {the resonator having more than two terminals (H03B 5/326 takes precedence)}	)/ 1 <del>7</del> 1	e.g. varactor}
5/326	the resonator being an acoustic wave device, e.g. SAW or BAW device}	9/142	• • • {and comprising a magnetic field sensitive element, e.g. YIG}
	e.g. of the device;	9/143	• • • {using more than one solid state device}

9/145	• • • {the frequency being determined by a cavity resonator, e.g. a hollow waveguide cavity or a coaxial cavity (H03B 9/141 - H03B 9/143, H03B 9/147, H03B 9/148 take precedence)}	21/02	• • by plural beating, i.e. for frequency synthesis; {Beating in combination with multiplication or division of frequency (digital frequency synthesis using a ROM <u>G06F 1/02</u> ; digital frequency
9/146	• • • • {formed by a disc, e.g. a waveguide cap resonator}		synthesis in general <u>H03K</u> ; indirect frequency synthesis using a PLL <u>H03L 7/16</u> )}
9/147	• • • {the frequency being determined by a stripline resonator ( <u>H03B 9/141</u> - <u>H03B 9/143</u> ,	21/025	• • • {by repeated mixing in combination with division of frequency only}
	H03B 9/148 take precedence)	21/04	using several similar stages
9/148	• • • {the frequency being determined by a dielectric resonator (H03B 9/141 - H03B 9/143 take precedence)}	23/00	Generation of oscillations periodically swept over a predetermined frequency range (angle-modulating circuits in general H03C 3/00)
11/00	Generation of oscillations using a shock-excited tuned circuit (with feedback H03B 5/00)	25/00	Simultaneous generation by a free-running oscillator of oscillations having different
11/02	• excited by spark (spark gaps therefor <u>H01T 9/00</u> )		frequencies
11/04	excited by interrupter		_
11/06	by mechanical interrupter	27/00	Generation of oscillations providing a plurality
11/08	interrupter being discharge tube		of outputs of the same frequency but differing in phase, other than merely two anti-phase outputs
11/10	interrupter being semiconductor device		
13/00	Generation of oscillations using deflection of electron beam in a cathode-ray tube	28/00	Generation of oscillations by methods not covered by groups <u>H03B 5/00</u> - <u>H03B 27/00</u> ,
15/00	Generation of oscillations using galvano-magnetic		including modification of the waveform to produce sinusoidal oscillations (analogue function generators
20,00	devices, e.g. Hall-effect devices, or using super-		for performing computing operations <u>G06G 7/26</u> ; use
	<b>conductivity effects</b> (galvano-magnetic devices <u>per</u> <u>se H01L 43/00</u> )		of transformers for conversion of waveform in ac-ac converters H02M 5/18)
15/003	• {using superconductivity effects (devices using superconductivity <u>H01L 39/00</u> )}	29/00	Generation of noise currents and voltages
15/006	• {using spin transfer effects or giant magnetoresistance}		{(gasfilled discharge tubes with solid cathode specially adapted as noise generators H01J 17/005)}
17/00	Generation of oscillations using radiation source	2200/00	Indexing scheme relating to details of oscillators covered by H03B
	and detector, e.g. with interposed variable obturator	2200/0002	Types of oscillators
		2200/0004	Butler oscillator
19/00	Generation of oscillations by non-regenerative	2200/0006	Clapp oscillator
19/00	frequency multiplication or division of a signal		Clapp oscillator     Colpitts oscillator
19/00	frequency multiplication or division of a signal from a separate source (transference of modulation	2200/0006	
	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another <u>H03D 7/00</u> )	2200/0006 2200/0008	Colpitts oscillator
19/03	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another <u>H03D 7/00</u> ) . using non-linear inductance	2200/0006 2200/0008 2200/001	Colpitts oscillator     Hartley oscillator
19/03 19/05	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  using non-linear inductance  using non-linear capacitance, e.g. varactor diodes	2200/0006 2200/0008 2200/001 2200/0012	<ul><li>Colpitts oscillator</li><li>Hartley oscillator</li><li>Pierce oscillator</li></ul>
19/03	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another <u>H03D 7/00</u> ) . using non-linear inductance	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0016	<ul> <li>Colpitts oscillator</li> <li>Hartley oscillator</li> <li>Pierce oscillator</li> <li>Structural aspects of oscillators</li> </ul>
19/03 19/05	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0016 2200/0018	<ul> <li>Colpitts oscillator</li> <li>Hartley oscillator</li> <li>Pierce oscillator</li> <li>Structural aspects of oscillators</li> <li>including a ring, disk or loop shaped resonator</li> <li>relating to the cutting angle of a crystal, e.g. AT cut quartz</li> </ul>
19/03 19/05 19/06	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  using non-linear inductance  using non-linear capacitance, e.g. varactor diodes  by means of discharge device or semiconductor device with more than two electrodes	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0016 2200/0018	<ul> <li>Colpitts oscillator</li> <li>Hartley oscillator</li> <li>Pierce oscillator</li> <li>Structural aspects of oscillators</li> <li>including a ring, disk or loop shaped resonator</li> <li>relating to the cutting angle of a crystal, e.g. AT cut quartz</li> <li>making use of ceramic material</li> </ul>
19/03 19/05 19/06	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  using non-linear inductance using non-linear capacitance, e.g. varactor diodes by means of discharge device or semiconductor device with more than two electrodes  by means of a discharge device	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0016 2200/0018 2200/002 2200/002	<ul> <li>Colpitts oscillator</li> <li>Hartley oscillator</li> <li>Pierce oscillator</li> <li>Structural aspects of oscillators</li> <li>including a ring, disk or loop shaped resonator</li> <li>relating to the cutting angle of a crystal, e.g. AT cut quartz</li> <li>making use of ceramic material</li> <li>characterised by the substrate, e.g. material</li> </ul>
19/03 19/05 19/06 19/08 19/10	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor device with more than two electrodes  . by means of a discharge device  . using multiplication only	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0016 2200/0018 2200/002 2200/0022 2200/0024	<ul> <li>Colpitts oscillator</li> <li>Hartley oscillator</li> <li>Pierce oscillator</li> <li>Structural aspects of oscillators</li> <li>including a ring, disk or loop shaped resonator</li> <li>relating to the cutting angle of a crystal, e.g. AT cut quartz</li> <li>making use of ceramic material</li> <li>characterised by the substrate, e.g. material</li> <li>including parallel striplines</li> </ul>
19/03 19/05 19/06 19/08 19/10 19/12	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor device with more than two electrodes  . by means of a discharge device  . using multiplication only  . using division only  . by means of a semiconductor device  . using uncontrolled rectifying devices, e.g. rectifying	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0016 2200/0018 2200/002 2200/0022 2200/0024 2200/0026	<ul> <li>Colpitts oscillator</li> <li>Hartley oscillator</li> <li>Pierce oscillator</li> <li>Structural aspects of oscillators</li> <li>including a ring, disk or loop shaped resonator</li> <li>relating to the cutting angle of a crystal, e.g. AT cut quartz</li> <li>making use of ceramic material</li> <li>characterised by the substrate, e.g. material</li> <li>including parallel striplines</li> <li>relating to the pins of integrated circuits</li> </ul>
19/03 19/05 19/06 19/08 19/10 19/12 19/14 19/16	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor device with more than two electrodes  . by means of a discharge device  . using multiplication only  . using division only  . by means of a semiconductor device  . using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0016 2200/0018 2200/002 2200/0022 2200/0024	<ul> <li>Colpitts oscillator</li> <li>Hartley oscillator</li> <li>Pierce oscillator</li> <li>Structural aspects of oscillators</li> <li>including a ring, disk or loop shaped resonator</li> <li>relating to the cutting angle of a crystal, e.g. AT cut quartz</li> <li>making use of ceramic material</li> <li>characterised by the substrate, e.g. material</li> <li>including parallel striplines</li> <li>relating to the pins of integrated circuits</li> <li>based on a monolithic microwave integrated</li> </ul>
19/03 19/05 19/06 19/08 19/10 19/12 19/14	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor device with more than two electrodes  . by means of a discharge device  . using multiplication only  . using division only  . by means of a semiconductor device  . using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes  . and elements comprising distributed inductance	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0016 2200/0018 2200/002 2200/0022 2200/0024 2200/0026	Colpitts oscillator     Hartley oscillator     Pierce oscillator     Structural aspects of oscillators     including a ring, disk or loop shaped resonator     relating to the cutting angle of a crystal, e.g. AT cut quartz     making use of ceramic material     characterised by the substrate, e.g. material     including parallel striplines     relating to the pins of integrated circuits     based on a monolithic microwave integrated circuit [MMIC]
19/03 19/05 19/06 19/08 19/10 19/12 19/14 19/16	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor device with more than two electrodes  . by means of a discharge device  . using multiplication only  . using division only  . by means of a semiconductor device  . using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes  . and elements comprising distributed inductance and capacitance	2200/0006 2200/0008 2200/0011 2200/0012 2200/0014 2200/0016 2200/0018 2200/002 2200/0022 2200/0024 2200/0026 2200/0028	Colpitts oscillator     Hartley oscillator     Pierce oscillator     Structural aspects of oscillators     including a ring, disk or loop shaped resonator     relating to the cutting angle of a crystal, e.g. AT cut quartz     making use of ceramic material     characterised by the substrate, e.g. material     including parallel striplines     relating to the pins of integrated circuits     based on a monolithic microwave integrated circuit [MMIC]     Circuit elements of oscillators
19/03 19/05 19/06 19/08 19/10 19/12 19/14 19/16	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor device with more than two electrodes  . by means of a discharge device  . using multiplication only  . using division only  . by means of a semiconductor device  . using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes  . and elements comprising distributed inductance	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0016 2200/002 2200/002 2200/0022 2200/0024 2200/0026 2200/0028	Colpitts oscillator     Hartley oscillator     Pierce oscillator     Structural aspects of oscillators     including a ring, disk or loop shaped resonator     relating to the cutting angle of a crystal, e.g. AT cut quartz     making use of ceramic material     characterised by the substrate, e.g. material     including parallel striplines     relating to the pins of integrated circuits     based on a monolithic microwave integrated circuit [MMIC]     Circuit elements of oscillators
19/03 19/05 19/06 19/08 19/10 19/12 19/14 19/16 19/18	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor device with more than two electrodes  . by means of a discharge device  . using multiplication only  . using division only  . by means of a semiconductor device  . using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes  . and elements comprising distributed inductance and capacitance  . being diodes exhibiting charge storage or enhancement effects	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0018 2200/002 2200/0022 2200/0024 2200/0028 2200/003 2200/003 2200/0034	Colpitts oscillator     Hartley oscillator     Pierce oscillator     Structural aspects of oscillators     including a ring, disk or loop shaped resonator     relating to the cutting angle of a crystal, e.g. AT cut quartz     making use of ceramic material     characterised by the substrate, e.g. material     including parallel striplines     relating to the pins of integrated circuits     based on a monolithic microwave integrated circuit [MMIC]     Circuit elements of oscillators     including a device with a Schottky junction
19/03 19/05 19/06 19/08 19/10 19/12 19/14 19/16	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  using non-linear inductance  using non-linear capacitance, e.g. varactor diodes  by means of discharge device or semiconductor device with more than two electrodes  by means of a discharge device  using multiplication only  using division only  by means of a semiconductor device  using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes  and elements comprising distributed inductance and capacitance  being diodes exhibiting charge storage or enhancement effects  Generation of oscillations by combining	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0018 2200/002 2200/0022 2200/0024 2200/0028 2200/003 2200/003 2200/0034	Colpitts oscillator     Hartley oscillator     Pierce oscillator     Structural aspects of oscillators     including a ring, disk or loop shaped resonator     relating to the cutting angle of a crystal, e.g. AT cut quartz     making use of ceramic material     characterised by the substrate, e.g. material     including parallel striplines     relating to the pins of integrated circuits     based on a monolithic microwave integrated circuit [MMIC]     Circuit elements of oscillators     including a device with a Schottky junction     including a buffer amplifier
19/03 19/05 19/06 19/08 19/10 19/12 19/14 19/16 19/18	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  using non-linear inductance  using non-linear capacitance, e.g. varactor diodes  by means of discharge device or semiconductor device with more than two electrodes  by means of a discharge device  using multiplication only  using division only  by means of a semiconductor device  using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes  and elements comprising distributed inductance and capacitance  being diodes exhibiting charge storage or enhancement effects  Generation of oscillations by combining unmodulated signals of different frequencies	2200/0006 2200/0008 2200/001 2200/0012 2200/0014 2200/0018 2200/002 2200/0022 2200/0024 2200/0028 2200/003 2200/003 2200/0034	Colpitts oscillator     Hartley oscillator     Pierce oscillator     Structural aspects of oscillators     including a ring, disk or loop shaped resonator     relating to the cutting angle of a crystal, e.g. AT cut quartz     making use of ceramic material     characterised by the substrate, e.g. material     including parallel striplines     relating to the pins of integrated circuits     based on a monolithic microwave integrated circuit [MMIC]     Circuit elements of oscillators     including a device with a Schottky junction     including a buffer amplifier     including an emitter or source coupled transistor pair or a long tail pair     including a current mirror
19/03 19/05 19/06 19/08 19/10 19/12 19/14 19/16 19/18	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  using non-linear inductance  using non-linear capacitance, e.g. varactor diodes  by means of discharge device or semiconductor device with more than two electrodes  by means of a discharge device  using multiplication only  using division only  by means of a semiconductor device  using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes  and elements comprising distributed inductance and capacitance  being diodes exhibiting charge storage or enhancement effects  Generation of oscillations by combining unmodulated signals of different frequencies (H03B 19/00 takes precedence; frequency changing	2200/0006 2200/0008 2200/0011 2200/0012 2200/0014 2200/0018 2200/002 2200/0022 2200/0024 2200/0026 2200/003 2200/003 2200/0034 2200/0036	<ul> <li>Colpitts oscillator</li> <li>Hartley oscillator</li> <li>Pierce oscillator</li> <li>Structural aspects of oscillators</li> <li>including a ring, disk or loop shaped resonator</li> <li>relating to the cutting angle of a crystal, e.g. AT cut quartz</li> <li>making use of ceramic material</li> <li>characterised by the substrate, e.g. material</li> <li>including parallel striplines</li> <li>relating to the pins of integrated circuits</li> <li>based on a monolithic microwave integrated circuit [MMIC]</li> <li>Circuit elements of oscillators</li> <li>including a device with a Schottky junction</li> <li>including a buffer amplifier</li> <li>including an emitter or source coupled transistor pair or a long tail pair</li> <li>including a variable capacitance, e.g. a varicap,</li> </ul>
19/03 19/05 19/06 19/08 19/10 19/12 19/14 19/16 19/18	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor device with more than two electrodes  . by means of a discharge device  . using multiplication only  . using division only  . by means of a semiconductor device  . using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes  . and elements comprising distributed inductance and capacitance  . being diodes exhibiting charge storage or enhancement effects  Generation of oscillations by combining unmodulated signals of different frequencies (H03B 19/00 takes precedence; frequency changing circuits in general H03D)  . by beating unmodulated signals of different	2200/0006 2200/0008 2200/0011 2200/0012 2200/0014 2200/0018 2200/002 2200/0022 2200/0024 2200/0026 2200/003 2200/003 2200/0036 2200/0038	Colpitts oscillator     Hartley oscillator     Pierce oscillator     Structural aspects of oscillators     including a ring, disk or loop shaped resonator     relating to the cutting angle of a crystal, e.g. AT cut quartz     making use of ceramic material     characterised by the substrate, e.g. material     including parallel striplines     relating to the pins of integrated circuits     based on a monolithic microwave integrated circuit [MMIC]     Circuit elements of oscillators     including a device with a Schottky junction     including a buffer amplifier     including an emitter or source coupled transistor pair or a long tail pair     including a current mirror
19/03 19/05 19/06 19/08 19/10 19/12 19/14 19/16 19/18 19/20 <b>21/00</b>	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor device with more than two electrodes  . by means of a discharge device  . using multiplication only  . using division only  . by means of a semiconductor device  . using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes  . and elements comprising distributed inductance and capacitance  . being diodes exhibiting charge storage or enhancement effects  Generation of oscillations by combining unmodulated signals of different frequencies (H03B 19/00 takes precedence; frequency changing circuits in general H03D)	2200/0006 2200/0008 2200/0011 2200/0012 2200/0014 2200/0018 2200/002 2200/0022 2200/0024 2200/0026 2200/003 2200/003 2200/0036 2200/0038	<ul> <li>Colpitts oscillator</li> <li>Hartley oscillator</li> <li>Pierce oscillator</li> <li>Structural aspects of oscillators</li> <li>including a ring, disk or loop shaped resonator</li> <li>relating to the cutting angle of a crystal, e.g. AT cut quartz</li> <li>making use of ceramic material</li> <li>characterised by the substrate, e.g. material</li> <li>including parallel striplines</li> <li>relating to the pins of integrated circuits</li> <li>based on a monolithic microwave integrated circuit [MMIC]</li> <li>Circuit elements of oscillators</li> <li>including a device with a Schottky junction</li> <li>including a buffer amplifier</li> <li>including an emitter or source coupled transistor pair or a long tail pair</li> <li>including a variable capacitance, e.g. a varicap, a varactor or a variable capacitance of a diode or transistor</li> <li>the capacitance diode being in the feedback</li> </ul>
19/03 19/05 19/06 19/08 19/10 19/12 19/14 19/16 19/18 19/20 <b>21/00</b>	frequency multiplication or division of a signal from a separate source (transference of modulation from one carrier to another H03D 7/00)  . using non-linear inductance  . using non-linear capacitance, e.g. varactor diodes  . by means of discharge device or semiconductor device with more than two electrodes  . by means of a discharge device  . using multiplication only  . using division only  . by means of a semiconductor device  . using uncontrolled rectifying devices, e.g. rectifying diodes or Schottky diodes  . and elements comprising distributed inductance and capacitance  . being diodes exhibiting charge storage or enhancement effects  Generation of oscillations by combining unmodulated signals of different frequencies (H03B 19/00 takes precedence; frequency changing circuits in general H03D)  . by beating unmodulated signals of different	2200/0006 2200/0008 2200/0011 2200/0012 2200/0014 2200/0016 2200/002 2200/0022 2200/0024 2200/0028 2200/003 2200/003 2200/0034 2200/0036 2200/0038 2200/0038	<ul> <li>Colpitts oscillator</li> <li>Hartley oscillator</li> <li>Pierce oscillator</li> <li>Structural aspects of oscillators</li> <li>including a ring, disk or loop shaped resonator</li> <li>relating to the cutting angle of a crystal, e.g. AT cut quartz</li> <li>making use of ceramic material</li> <li>characterised by the substrate, e.g. material</li> <li>including parallel striplines</li> <li>relating to the pins of integrated circuits</li> <li>based on a monolithic microwave integrated circuit [MMIC]</li> <li>Circuit elements of oscillators</li> <li>including a device with a Schottky junction</li> <li>including a buffer amplifier</li> <li>including an emitter or source coupled transistor pair or a long tail pair</li> <li>including a variable capacitance, e.g. a varicap, a varactor or a variable capacitance of a diode or transistor</li> </ul>

2200/0046	including measures to switch the gain of an	2201/025 the means being an electronic switch for
2200/0040	amplifier	switching in or out oscillator elements
2200/0048	including measures to switch the frequency band, e.g. by harmonic selection	2201/0258 the means comprising a diode
2200/005		2201/0266 the means comprising a transistor
2200/005	including measures to switch a capacitor	2201/0275 the means delivering several selected voltages or
2200/0052	including measures to switch the feedback circuit	currents
2200/0054	including measures to switch a filter, e.g. for	2201/0283 the means functioning digitally
2200/0056	frequency tuning or for harmonic selection	2201/0291 and being controlled by a processing device,
2200/0056	including a diode used for switching	e.g. a microprocessor
2200/0058	with particular transconductance characteristics,	2201/03 • Varying beside the frequency also another
	e.g. an operational transconductance amplifier	parameter of the oscillator in dependence on the
2200/006	Functional aspects of oscillators	frequency
2200/0062	Bias and operating point	2201/031 the parameter being the amplitude of a signal, e.g.
2200/0064	• Pulse width, duty cycle or on/off ratio	maintaining a constant output amplitude over the
2200/0066	Amplitude or AM detection	frequency range
2200/0068	Frequency or FM detection	2201/033 the parameter being the amount of feedback
2200/007	Generation of oscillations based on harmonic	2201/035 . the parameter being another frequency, e.g. a
	frequencies, e.g. overtone oscillators	harmonic of the oscillating frequency
2200/0072	Frequency hopping and enabling of rapid	2201/036 the parameter being the quality factor of a
	frequency changes	resonator
2200/0074	Locking of an oscillator by injecting an input	2201/038 the parameter being a bias voltage or a power
	signal directly into the oscillator	supply
2200/0076	Power combination of several oscillators	2202/00 Aspects of oscillators relating to reduction of
	oscillating at the same frequency	undesired oscillations
2200/0078	generating or using signals in quadrature	2202/01 • Reduction of undesired oscillations originated
2200/008	making use of a reference frequency	from distortion in one of the circuit elements of the
2200/0082	Lowering the supply voltage and saving power	oscillator
2200/0084	dedicated to Terahertz frequencies	2202/012 the circuit element being the active device
2200/0086	• relating to the Q factor or damping of the resonant	2202/015 . the circuit element being a limiter
	circuit	2202/017 . the circuit element being a frequency determining
2200/0088	Reduction of noise	element
2200/009	Reduction of phase noise	2202/02 • Reduction of undesired oscillations originated from
2200/0092	Measures to linearise or reduce distortion of	natural noise of the circuit elements of the oscillator
2200,0002	oscillator characteristics	2202/022 • the noise being essentially white noise, i.e.
2200/0094	Measures to ensure starting of oscillations	frequency independent noise
2200/0096	Measures to ensure stopping of oscillations	2202/025 • the noise being coloured noise, i.e. frequency
2200/0098	having a balanced output signal	dependent noise
2200,0000	v v maxing a cananeca carpar signar	2202/027 the noise being essentially proportional to the
2201/00	Aspects of oscillators relating to varying the	inverse of the frequency, i.e. the so-called 1/f
	frequency of the oscillations	noise
2201/01	Varying the frequency of the oscillations by manual	2202/03 • Reduction of undesired oscillations originated from
	means	internal parasitic couplings, i.e. parasitic couplings
2201/011	the means being an element with a variable	within the oscillator itself
	capacitance	2202/04 • Reduction of undesired oscillations originated
2201/012	the means being an element with a variable	from outside noise or interferences, e.g. from
	inductance	parasitic couplings with circuit elements outside the
2201/014	the means being associated with an element	oscillator
	comprising distributed inductances and	2202/042 the circuit element belonging to the power supply
	capacitances	2202/044 the circuit element belonging to transmitter
2201/015	the element being a cavity	circuitry
2201/017	the element being a dielectric resonator	2202/046 the circuit element belonging to receiver circuitry
2201/018	the means being a manual switch	2202/048 the circuit element being a frequency divider
2201/02	• Varying the frequency of the oscillations by	2202/05 • Reduction of undesired oscillations through filtering
	electronic means	or through special resonator characteristics
2201/0208	• • the means being an element with a variable	2202/06 • Reduction of undesired oscillations through
	capacitance, e.g. capacitance diode	modification of a bias voltage, e.g. selecting the
2201/0216	the means being an element with a variable	operation point of an active device
	inductance	2202/07 • Reduction of undesired oscillations through a
2201/0225	the means being associated with an element	cancelling of the undesired oscillation
	comprising distributed inductances and	2202/073 by modifying the internal feedback of the
	capacitances	oscillator
2201/0233	the element being a cavity	2202/076 by using a feedback loop external to the
2201/0241	the element being a magnetically variable	oscillator, e.g. the so-called noise degeneration
	element, e.g. an Yttrium Iron Garnet	

## H03B

2202/08	• Reduction of undesired oscillations originated from
	the oscillator in circuit elements external to the
	oscillator by means associated with the oscillator
2202/082	by avoiding coupling between these circuit
	elements
2202/084	through shielding
2202/086	through a frequency dependent coupling, e.g.
	which attenuates a certain frequency range
2202/088	by compensating through additional couplings
	with these circuit elements